506430294 01/04/2021

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 EPAS ID: PAT6477061 Stylesheet Version v1.2

SUBMISSION TYPE: NEW ASSIGNMENT

NATURE OF CONVEYANCE: ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
CHIA-LIANG (LEON) LIN	12/20/2020

RECEIVING PARTY DATA

Name:	REALTEK SEMICONDUCTOR CORP.
Street Address:	NO. 2, INNOVATION RD. II
Internal Address:	SCIENCE-BASED INDUSTRIAL PARK
City:	HSINCHU
State/Country:	TAIWAN
Postal Code:	300

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17140179

CORRESPONDENCE DATA

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Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

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ATTORNEY DOCKET NUMBER: 251812-5660

NAME OF SUBMITTER: DANIEL R. MCCLURE

SIGNATURE: /Daniel R. McClure/

DATE SIGNED: 01/04/2021

Total Attachments: 1

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PATENT 506430294 REEL: 054794 FRAME: 0077

ASSIGNMENT OF UTILITY PATENT APPLICATION

WHEREAS, the following parties:

<u>Name</u>	<u>Address</u>
Chia-Liang (Leon) Lin	39566 Benavente Place
	Fremont, CA 94539

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements ("invention(s)") as described and set forth in the below-identified utility application for United States Letters Patent entitled:

HIGH-FREQUENCY SIGNAL DETECTOR AND METHOD THEREOF

which was:		
\boxtimes	executed on even date herewith,	
	filed with the United States Patent and Trademark Office (U	SPTO) on
	and assigned Serial No. , and	
	further described in U.S. Provisional application entitled	, filed with the
	USPTO on , and assigned Serial No	

Note: Only one of the first two checkboxes will be checked. The third checkbox will be checked, only if appropriate.

WHEREAS, Realtek Semiconductor Corp., having a place of business at No. 2, Innovation Rd. II, Science-Based Industrial Park, Hsinchu 300, Taiwan R.O.C., hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in and to said invention(s), said utility application, said provisional application, and any U.S. and foreign patents which are related to the same.

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged by ASSIGNOR, ASSIGNOR has sold, assigned and transferred and does hereby sell, assign and transfer unto ASSIGNEE, and ASSIGNEE'S successors and assigns, (a) the entire right, title and interest, for the United States of America, in and to said invention(s), said utility application, and said Provisional application and all the rights and privileges in any application and under any and all patents that may be granted in the U.S. for said inventions, including all corresponding provisional, continuation, continuation-in-part, divisional, reissue, and reexamination applications; and (b) the entire right, title and interest in and to said invention(s), said utility application, and said provisional application for all countries foreign to the U.S., including all rights of priority arising from them, and all the rights and privileges under any and all forms of protection, including patents, that may be granted in said countries foreign to the U.S. for them.

PATENT REEL: 054794 FRAME: 0078

RECORDED: 01/04/2021